

Triple 8-Bit, 40 MSPS, RGB, 3-Channel D/A Converter

March 1998

Features

- Resolution Triple 8-Bit
- Maximum Conversion Speed 40MHz
- RGB 3-Channel Input/Output
- Differential Linearity Error +0.3 LSB
- Low Power Consumption 240mW (200Ω Load for 2V_{p-p} Output)
- Single Power Supply +5V
- Low Glitch Noise
- Direct Replacement for Sony CXD1178

Applications

- Digital TV
- Graphics Display
- High Resolution Color Graphics
- Video Reconstruction
- Instrumentation
- Image Processing
- I/Q Modulation

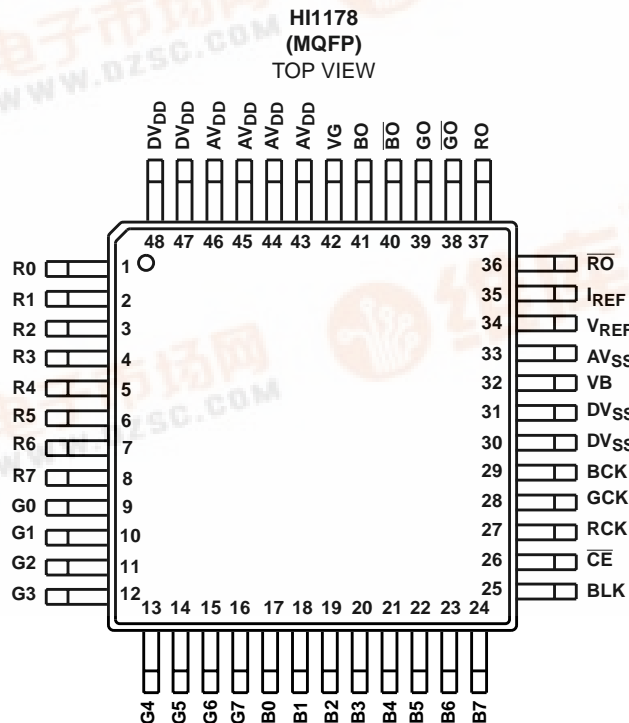
Description

The HI1178 is a triple 8-bit, high-speed, CMOS D/A converter designed for video band use. It has three separate, 8-bit, pixel inputs, one each for red, green, and blue video data. A single 5.0V power supply and pixel clock input is all that is required to make the device operational. A bias voltage generator is internal. Each channel clock input can be controlled individually, or connected together as one. The HI1178 also has BLANK video control signal. Refer to the HI2304 for 3.3V operation.

Ordering Information

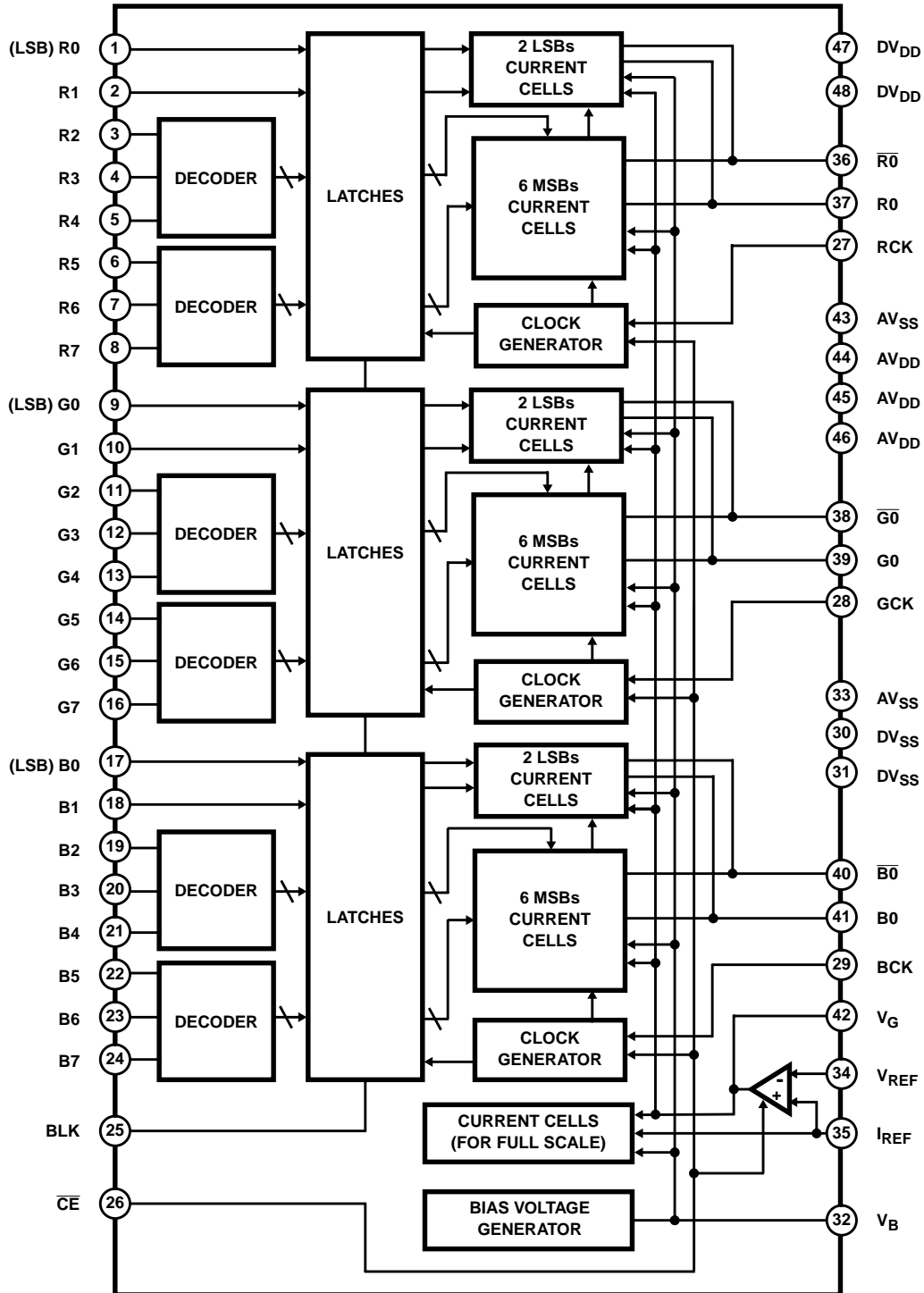
PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
HI1178JCQ	-40 to 85	48 Ld MQFP	Q48.12x12-S

Pinout



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Functional Block Diagram



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Pin Descriptions

PIN NO.	SYMBOL	EQUIVALENT CIRCUIT	DESCRIPTION
1 to 8	R0 to R7		Digital input.
9 to 16	G0 to G7		
17 to 24	B0 to B7		
25	BLK		Blanking pin. No signal at "H" (Output 0V). Output condition at "L".
32	V _B		Connect a capacitor of about 0.1μF.
27	RCK		Clock pin. Moreover all input pins are TTL-CMOS compatible.
28	CLK		
29	BCK		
30, 31	DVSS		Digital GND.
33	AVSS		Analog GND.
26	CE		Chip enable pin. No signal (Output 0V) at "H" and minimizes power consumption.

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Pin Descriptions (Continued)

PIN NO.	SYMBOL	EQUIVALENT CIRCUIT	DESCRIPTION
35	I_{REF}		Connect a resistance 16 times "16R" that of output resistance value "R".
34	V_{REF}		Set full scale output value.
42	V_G		Connect a capacitor of about 0.1 μ F.
43 to 46	AV_{DD}		Analog V_{DD} .
37	RO		Current output pin. Voltage output can be obtained by connecting a resistance.
39	GO		Inverted current output pin. Normally dropped to analog GND.
41	BO		
36	\overline{RO}		
38	\overline{GO}		
40	BO		
47, 48	DV_{DD}		Digital V_{DD} .

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Timing Diagram

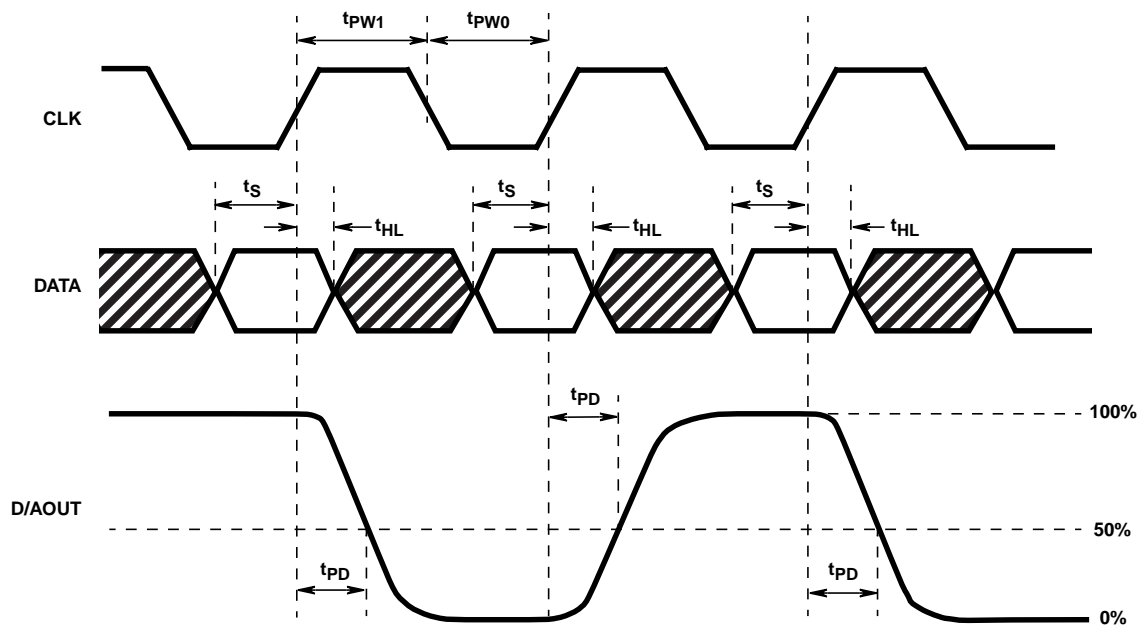


FIGURE 1.

Test Circuits

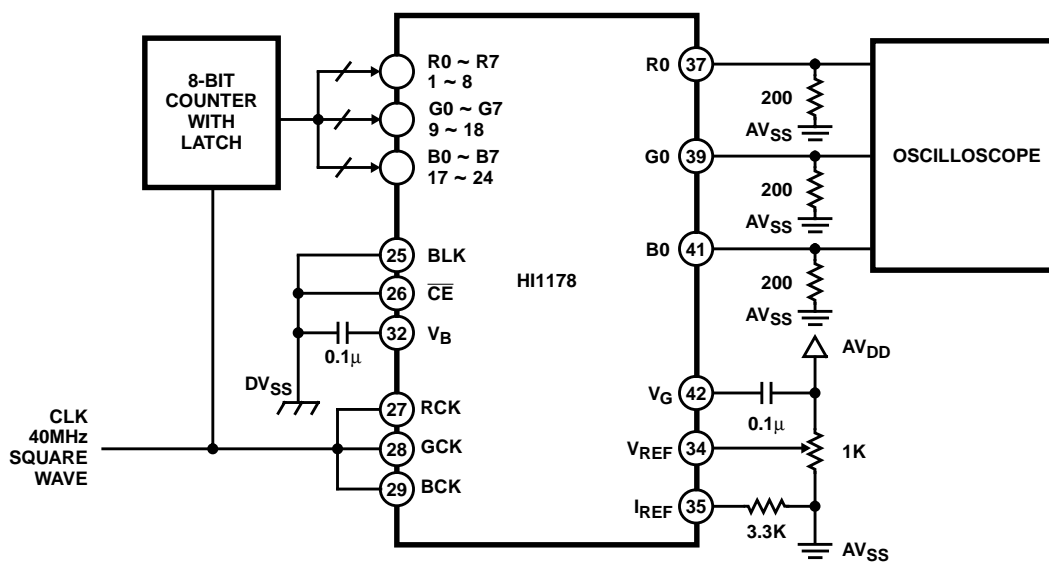


FIGURE 2. MAXIMUM CONVERSION RATE TEST CIRCUIT

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Test Circuits (Continued)

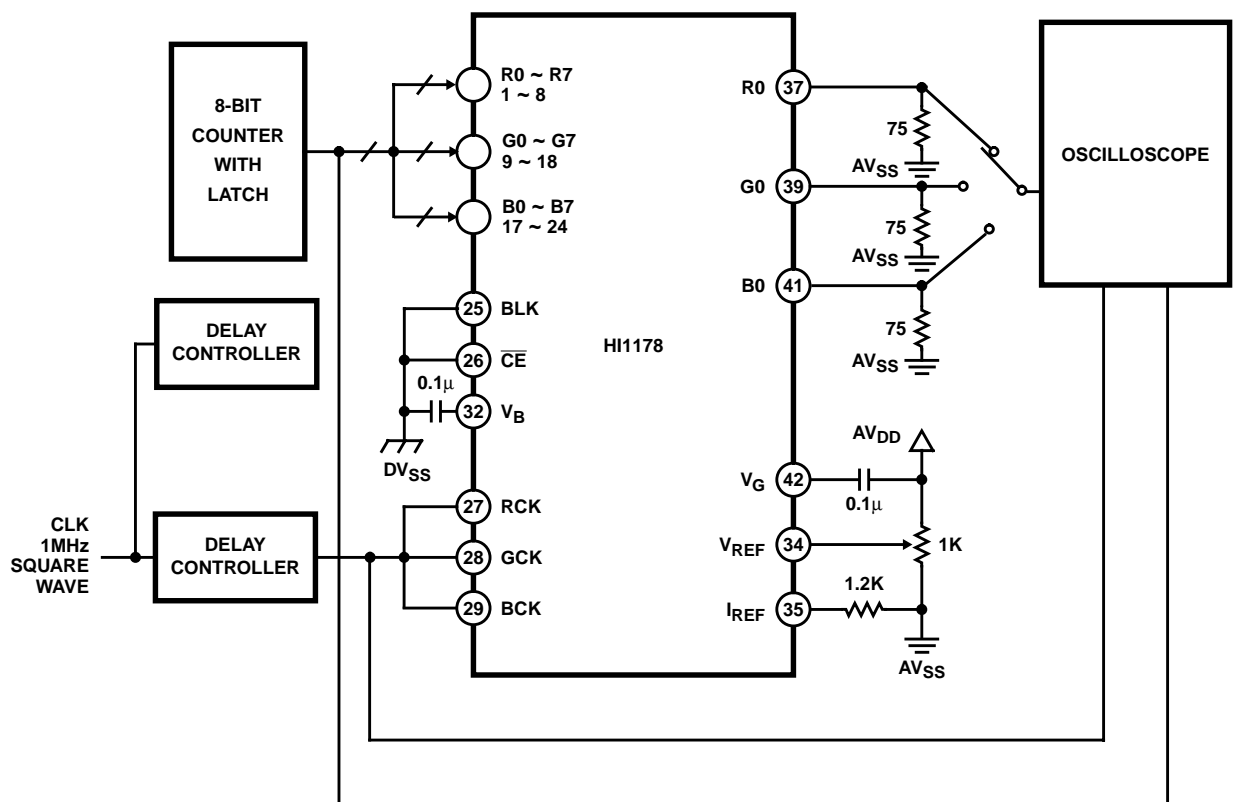


FIGURE 3. SETUP HOLD TIME AND GLITCH ENERGY TEST CIRCUIT

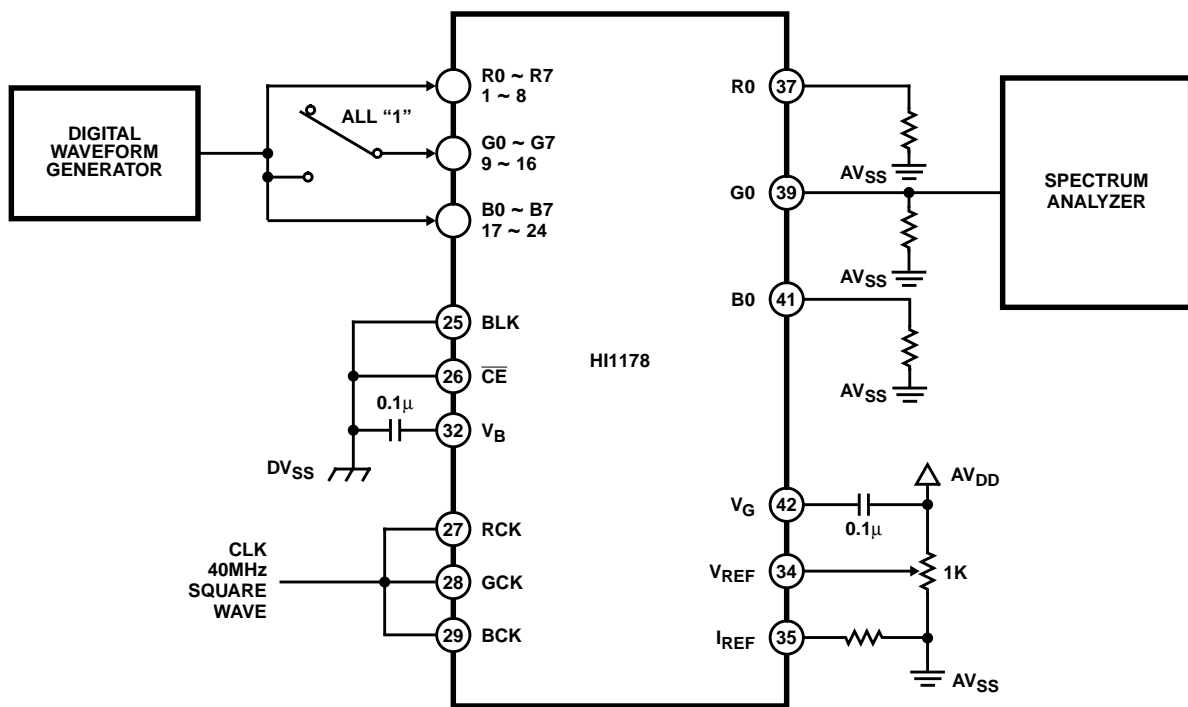


FIGURE 4. CROSSTALK TEST CIRCUIT

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Test Circuits (Continued)

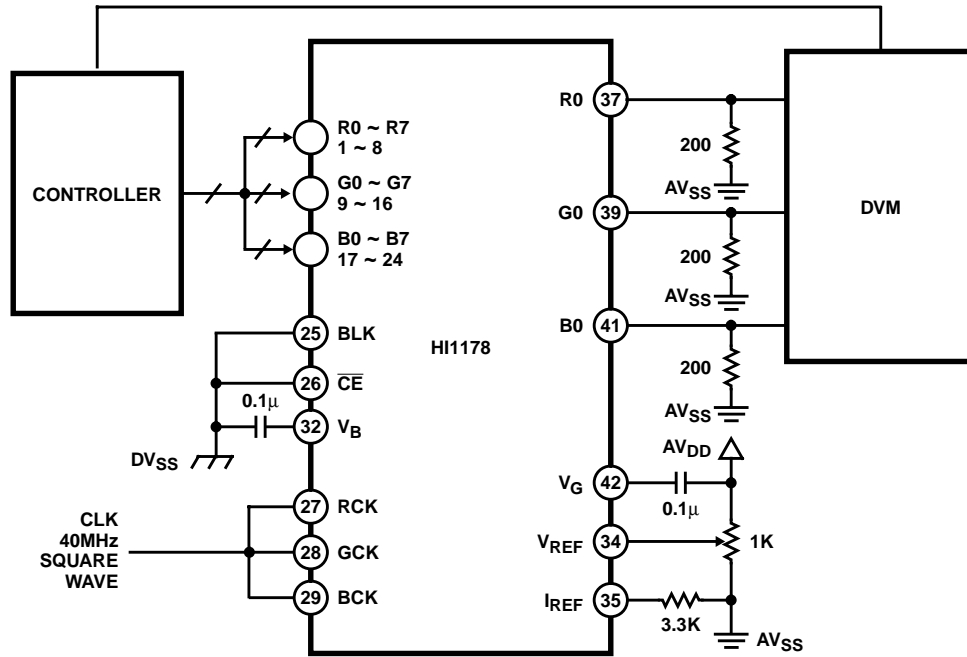


FIGURE 5. DC CHARACTERISTICS TEST CIRCUIT

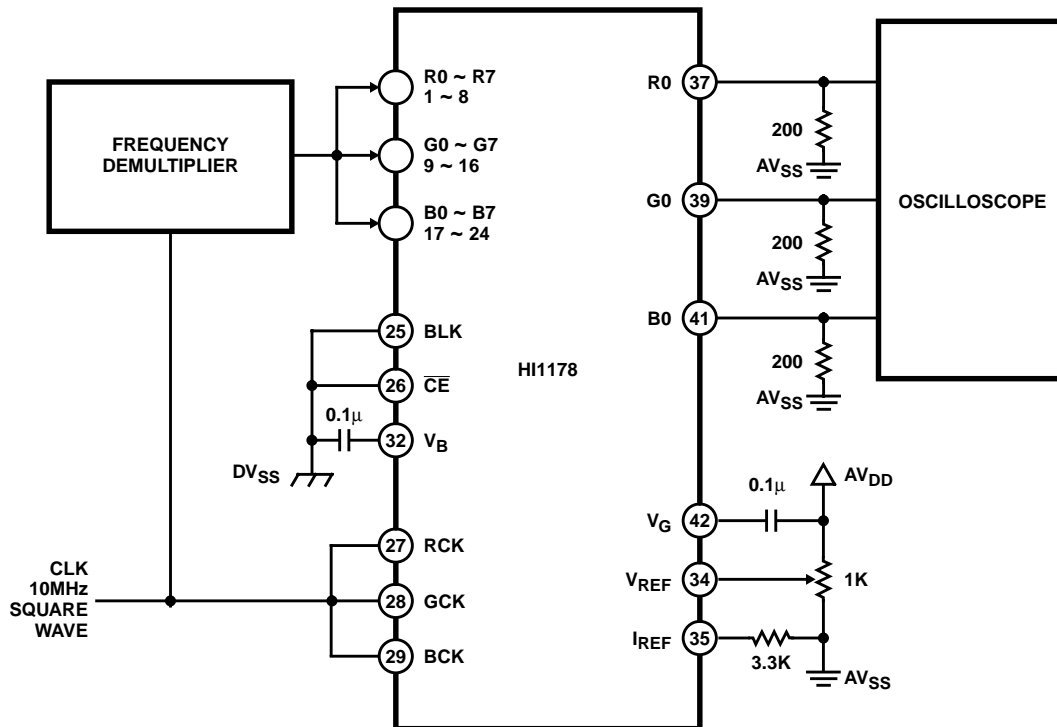


FIGURE 6. PROPAGATION DELAY TIME TEST CIRCUIT

Typical Performance Curves

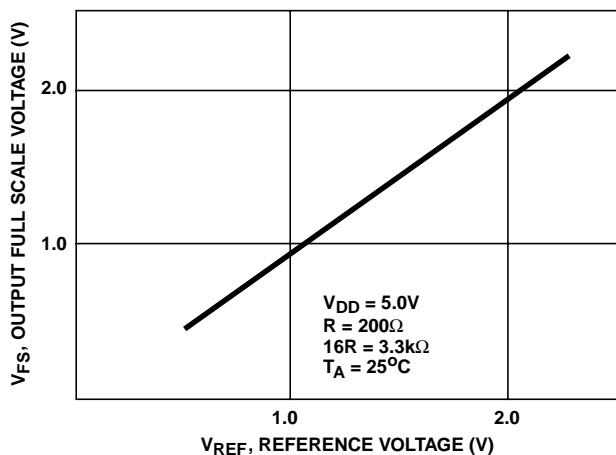


FIGURE 7. OUTPUT FULL SCALE VOLTAGE vs REFERENCE VOLTAGE

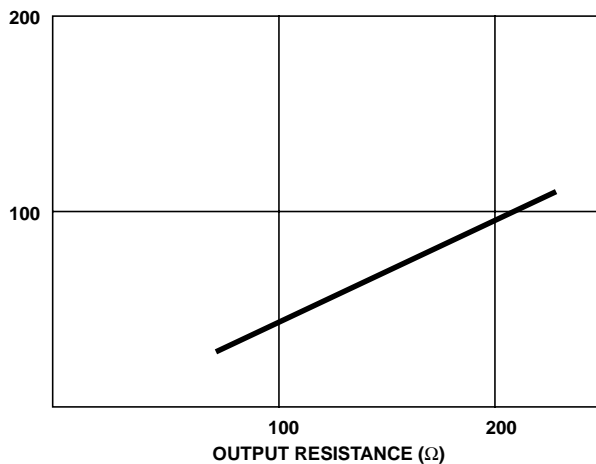


FIGURE 8. GLITCH ENERGY vs OUTPUT RESISTANCE

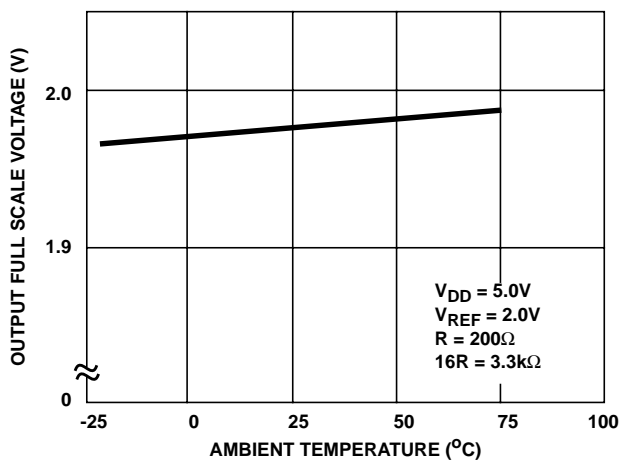


FIGURE 9. OUTPUT FULL SCALE VOLTAGE vs AMBIENT TEMPERATURE

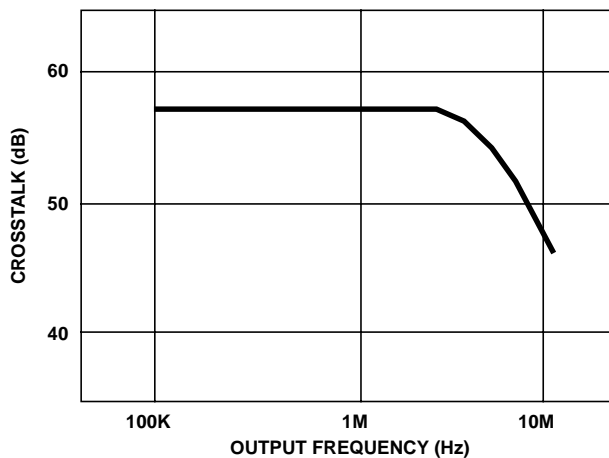


FIGURE 10. CROSSTALK vs OUTPUT FREQUENCY

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Application Circuit

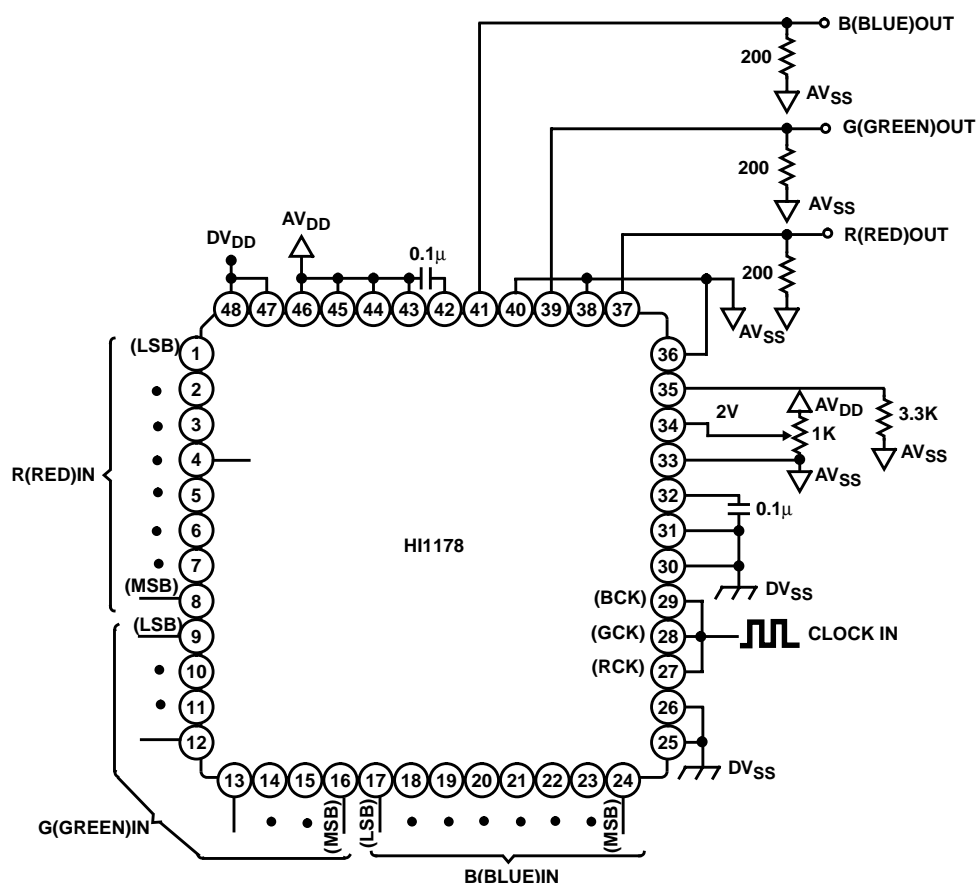


FIGURE 11.

Notes On Operation

- How to select the output resistance

The HI1178 is a current-output D/A converter. To obtain the output voltage, connect the resistance to IO pin (RO, GO, BO). For specifications we have:

Output Full Scale Voltage $V_{FS} = \text{less than } 2.0 \text{ [V]}$

Output Full Scale Current $I_{FS} = \text{less than } 15 \text{ [mA]}$

Calculate the output resistance value from the relation of $V_{FS} = I_{FS} \times R$. Also, 16 times resistance of the output resistance is connected to reference current pin I_{REF} . In some cases, however, this turns out to be a value that does not actually exist. In such a case a value close to it can be used as a substitute. Here please note that V_{FS} becomes $V_{FS} = V_{REF} \times 16R/R'$. R is the resistance connected to IO while R' is connected to I_{REF} . Increasing the resistance value can curb power consumption. On the other hand glitch energy and data settling time will

inversely increase. Set the most suitable value according to the desired application.

- Phase Relation Between Data and Clock

To obtain the expected performance as a D/A converter, it is necessary to set properly the phase relation between data and clock applied from the exterior. Be sure to satisfy the provisions of the set up time (t_S) and hold time (t_H) as stipulated in the Electrical Characteristics.

- V_{DD} , V_{SS}

To reduce noise effects separate analog and digital systems in the device periphery. For V_{DD} pins, both digital and analog, bypass respective GNDs by using a ceramic capacitor of $0.1\mu\text{F}$, as close as possible to the pin.

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